

Features

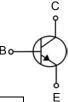
- Collector Current Capability Ic=0.2A
- Collector Emitter Voltage VcEo=40V

Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
AC847BWQ-7	SOT-323	1F	3000



SOT-323



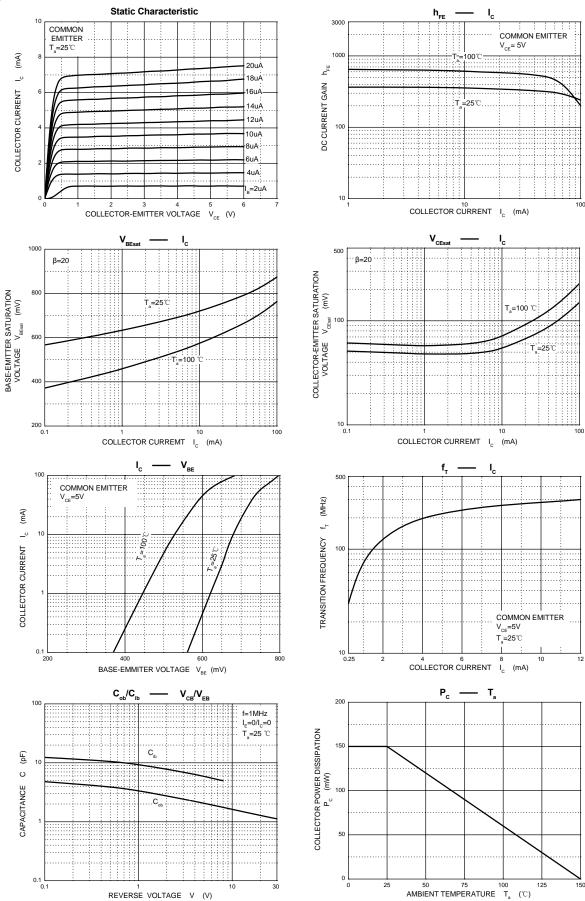
Maximum Ratings (Ta=25°C unless otherwise noted)

Symbol	Parameter	Value	Unit
V _{CBO}	Collector-Base Voltage	50	V
V _{CEO}	Collector-Emitter Voltage	45	V
V _{EBO}	Emitter-Base Voltage	6	V
Ic	Collector Current –Continuous	0.1	Α
Pc	Collector Power Dissipation	150	mW
R _{OJA}	Thermal Resistance From Junction To Ambient	833	°C/W
T_J, T_{stg}	Operation Junction and Storage Temperature Range	-55-150	°C

Electrical Characteristics (Ta=25°C unless otherwise specified)

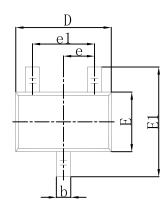
Parameter	Symbol	Test conditions	Min	Тур	Max	Unit	
Collector-base breakdown voltage	V_{CBO}	I _C = 10μΑ, I _E =0	50			٧	
Collector-emitter breakdown voltage	V _{CEO}	I _C = 10mA, I _B =0	45			V	
Emitter-base breakdown voltage	V _{EBO}	I _E = 1 μA, I _C =0	6			V	
Collector Cutoff Current	I _{CBO}	V _{CB} =30V			15	nA	
PO 1 :		V_{CE} = 5V, I_{C} = 10 μ A		150			
DC current gain	h _{FE}	V_{CE} = 5V, I_{C} = 2mA	200		450		
Collector-emitter saturation voltage		I _C =10mA, I _B =0. 5mA			0.25	V	
Collector-efficier saturation voltage	V _{CE(sat)}	$I_C=100$ mA, $I_B=5$ mA			0.6	V	
Base-emitter saturation voltage	V _{BE(sat)}	I _C =10mA, I _B =0. 5mA		0.7		V	
Base-emitter saturation voitage		$I_C=100$ mA, $I_B=5$ mA		0.9			
Dage emitter veltage		V _{CE} = 5V, I _C = 2mA	580	660	700	mV	
Base-emitter voltage	V _{BE(on)}	V_{CE} = 5V, I_{C} = 10mA			770	IIIV	
Transition fraguency	f _T	V _{CE} = 5 V, I _C = 10mA	100			MHz	
Transition frequency		f=100MHz	100				
Collector output capacitance	C _{ob}	V _{CB} =10V,f=1MHz		4.5	pF		
		V _{CE} =5V,I _c =0.2mA,					
Noise figure	NF	f=1KHz,R _S =2KΩ			10	dB	
		BW=200Hz					

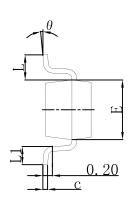
Typical Characteristics

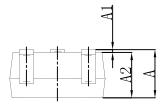




SOT-323 Package Outline Dimensions

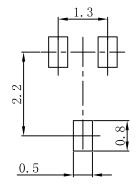






Symbol	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min	Max	Min	Max	
Α	0.900	1.100	0.035	0.043	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.000	0.035	0.039	
b	0.200	0.400	0.008	0.016	
С	0.080	0.150	0.003	0.006	
D	2.000	2.200	0.079	0.087	
E	1.150	1.350	0.045	0.053	
E1	2.150	2.450	0.085	0.096	
е	0.650 TYP		0.026 TYP		
e1	1.200	1.400	0.047	0.055	
Ĺ	0.525 REF		0.021 REF		
L1	0.260	0.460	0.010	0.018	
θ	0°	8°	0°	8°	

SOT-323 Suggested Pad Layout



Note:

- 1.Controlling dimension:in millimeters.
- 2.General tolerance:±0.05mm.
- 3. The pad layout is for reference purposes only.



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